TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74AC273P, TC74AC273F, TC74AC273FT

Octal D-Type Flip Flop with Clear

The TC74AC273 is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate and double-layer metal wiring C^2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

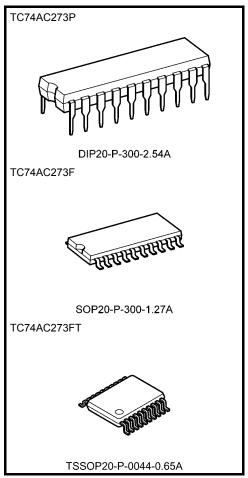
Information signals applied to D inputs are transferred to the Q output on the positive going edge of the clock pulse.

When the $\overline{\text{CLR}}$ input is held "L", the Q outputs are at a low logic level independent of the other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

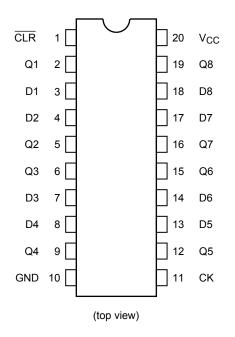
- High speed: $f_{max} = 170 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 8 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Symmetrical output impedance: $|\,I_{OH}\,|\,=I_{OL}=24~\text{mA (min) Capability of driving 50}~\Omega$ transmission lines.
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2 V to 5.5 V
- Pin and function compatible with 74F273



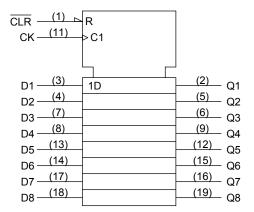
Weight

DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.)

Pin Assignment



IEC Logic Symbol

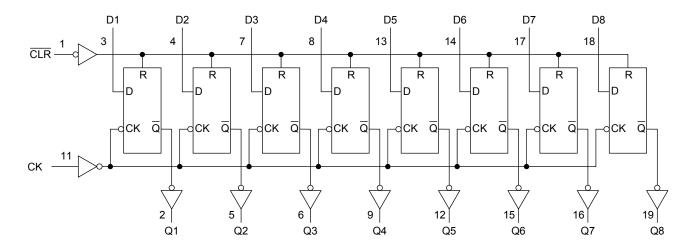


Truth Table

	Inputs		Output	Function			
CLR	D	CK	Q	runction			
L	Х	Х	L	Clear			
Н	L		L	_			
Н	Н		Н	_			
Н	Х	\rightarrow	Qn	No Change			

X: Don't care

System Diagram





Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V _{CC} /ground current	Icc	±200	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T _{stg}	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$, a derating factor of -10 mW/°C should be applied up to 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	2.0 to 5.5	V	
Input voltage	V _{IN}	0 to V _{CC}	V	
Output voltage	V _{OUT}	0 to V _{CC}	V	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V _{CC} = 3.3 ± 0.3 V)	ns/V	
input rise and fail tille	ui/uv	0 to 20 (V _{CC} = 5 ± 0.5 V)	115/ V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit		
Characteristics	Cymbol	moor		V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic		
				2.0	1.50	_	_	1.50	_			
High-level input voltage	V _{IH}		_		3.0	2.10	_	_	2.10	_	V	
Ţ.					5.5	3.85	—	_	3.85	—		
		_		2.0		_	0.50	_	0.50			
Low-level input voltage	V_{IL}				3.0	_	_	0.90	_	0.90	V	
					5.5	_	_	1.65	_	1.65		
	V _{ОН}		Ι _{ΟΗ} = -50 μΑ		2.0	1.9	2.0	_	1.9	_		
		V _{IN} = V _{IH} or V _{IL}			3.0	2.9	3.0	_	2.9	_		
High-level output					4.5	4.4	4.5	_	4.4	_		
voltage			$I_{OH} = -4 \text{ mA}$		3.0	2.58	_	_	2.48	_	•	
			$I_{OH} = -24 \text{ mA}$		4.5	3.94	_	_	3.80	_		
			$I_{OH} = -75 \text{ mA}$	(Note)	5.5	_	_	_	3.85	_		
	V _{OL}				2.0	_	0.0	0.1	_	0.1		
			$I_{OL} = 50 \mu A$		3.0	_	0.0	0.1	_	0.1		
Low-level output		V _{IN} = V _{IH} or V _{IL}			4.5	_	0.0	0.1	_	0.1	V	
voltage			I _{OL} = 12 mA		3.0	_	_	0.36	_	0.44	V	
			$I_{OL} = 24 \text{ mA}$		4.5	_	_	0.36	_	0.44		
			$I_{OL} = 75 \text{ mA}$	(Note)	5.5	_	_	_	_	1.65		
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5	l	_	±0.1	1	±1.0	μА		
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		5.5	_	_	8.0		80.0	μА		

Note: This spec indicates the capability of driving 50 Ω transmission lines. One output should be tested at a time for a 10 ms maximum duration.

Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition		Ta = 25°C	Ta = -40 to 85°C	Unit	
			V _{CC} (V)	Limit	Limit		
Minimum pulse width	t _{w (L)}		3.3 ± 0.3	8.0	8.0	20	
(CK)	t _{w (H)}	_	5.0 ± 0.5	5.0	5.0	ns	
Minimum pulse width	4		3.3 ± 0.3	7.5	7.5	20	
(CLR)	t _{w (L)}	_	5.0 ± 0.5	5.0	5.0	ns	
Minimum act up time			3.3 ± 0.3	8.5	8.5	20	
Minimum set-up time	t _s	_	5.0 ± 0.5	4.5	4.5	ns	
Minimum hold time	4.		3.3 ± 0.3	0.0	0.0	20	
Minimum noid time	t _h	_	5.0 ± 0.5	0.0	0.0	ns	
Minimum removal time	4		3.3 ± 0.3	7.0	7.0	20	
(CLR)	t _{rem}	_	5.0 ± 0.5	3.5	3.5	ns	



AC Characteristics (C_L = 50 pF, R_L = 500 Ω , input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	.,		V _{CC} (V)	Min	Тур.	Max	Min	Max	
Propagation delay time (CK-Q)	t _{pLH}	_	3.3 ± 0.3 5.0 ± 0.5	_	9.0 6.5	15.8 9.6	1.0 1.0	18.0 11.0	ns
Propagation delay time (CLR -Q)	t _{pHL}	_	3.3 ± 0.3 5.0 ± 0.5	_	8.0 5.9	14.0 9.2	1.0 1.0	16.0 10.5	ns
Maximum clock frequency	f _{max}	_	3.3 ± 0.3 5.0 ± 0.5	55 90	110 150	_	55 90	_	MHz
Input capacitance	C _{IN}	_		_	5	10	_	10	pF
Power dissipation capacitance	C _{PD}		(Note)	_	40	_	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per F/F)$$

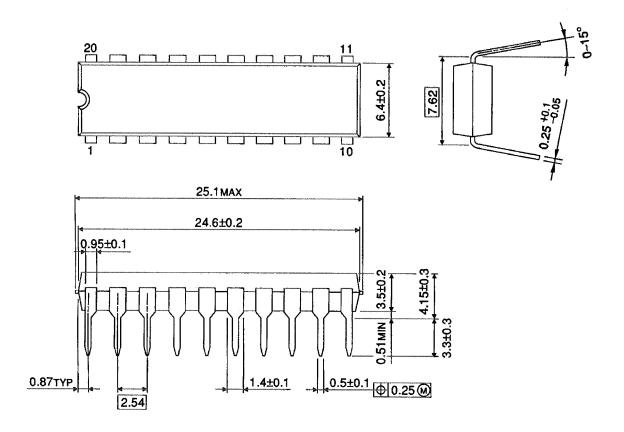
And the total $C_{\mbox{\scriptsize PD}}$ when n pcs. of flip flop operate can be gained by the following equation:

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$$C_{PD}$$
 (total) = 29 + 11·n

Package Dimensions

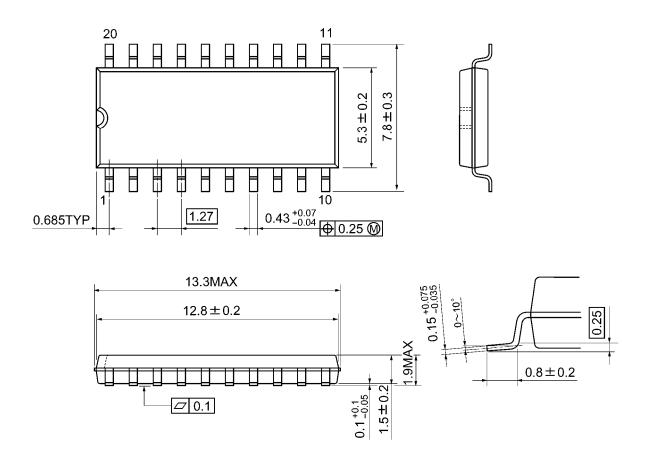
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A Unit: mm



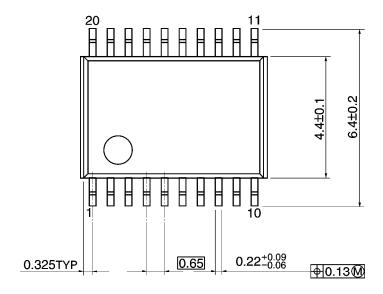
Weight: 0.22 g (typ.)

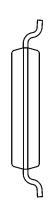
Package Dimensions

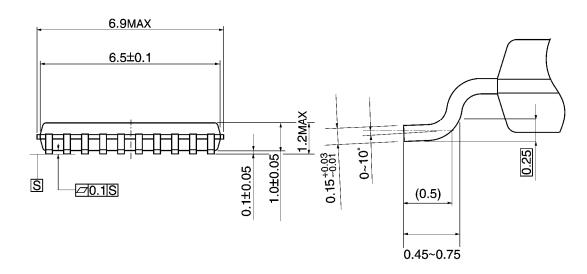
TOSHIBA

TSSOP20-P-0044-0.65A

Unit: mm







Weight: 0.08 g (typ.)

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